

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3059064

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HIROYUKI HOSHIYA	09/24/2014
TOMOMITSU INOUE	09/24/2014
TETSUYA MATSUZAKI	09/24/2014
HARUKAZU MIYAMOTO	09/24/2014
KAZUHITO MIYATA	09/24/2014
KENTARO NAMIKAWA	09/24/2014
ATSUKO OKAWA	10/01/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HGST NETHERLANDS B.V.
<b>Street Address:</b>	Herikerbergweg 238, Luna Arena
<b>City:</b>	1101 CM AMSTERDAM
<b>State/Country:</b>	NETHERLANDS
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14510377
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(408)717-9155
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	tom.berthold@comcast.net
<b>Correspondent Name:</b>	HGST, A WESTERN DIGITAL COMPANY
<b>Address Line 1:</b>	5600 COTTLE ROAD
<b>Address Line 4:</b>	SAN JOSE, CALIFORNIA 95193
<b>ATTORNEY DOCKET NUMBER:</b>	H20141180US1
<b>NAME OF SUBMITTER:</b>	THOMAS R. BERTHOLD
<b>SIGNATURE:</b>	/Thomas R. Berthold/
<b>DATE SIGNED:</b>	10/09/2014
<b>Total Attachments: 2</b>	
source=H20141180US1_AssignmentSigned#page1.tif	
source=H20141180US1_AssignmentSigned#page2.tif	

PATENT

## ASSIGNMENT FOR PATENT APPLICATION

Whereas, I/we the undersigned inventor(s) have invented certain improvements as set forth in the patent application entitled:

HEAT-ASSISTED MAGNETIC RECORDING (HAMR) WRITE HEAD WITH RECESSED NEAR-FIELD TRANSDUCER AND OPTICALLY TRANSPARENT PROTECTIVE FILM

Whereas, **HGST Netherlands B.V.**, having a place of business at Herikerbergweg 238, Luna Arena, 1101 CM Amsterdam, The Netherlands (hereinafter referred to as "HGST"), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby sell, assign, and transfer to HGST, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HGST, its successors and assigns; and we hereby agree that HGST may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HGST.

Signed on the date(s) indicated beside my (our) signature(s).

1.	Full Name	<b>Hiroyuki Hoshiya</b>
	Inventor's Signature	<i>Hiroyuki Hoshiya</i> date 24-Sep, 2014

2.	Full Name	<b>Tomomitsu Inoue</b>
	Inventor's Signature	<i>Tomomitsu Inoue</i> date 24-SEP-2014

3.	Full Name	<b>Tetsuya Matsuzaki</b>
	Inventor's Signature	<i>Tetsuya Matsuzaki</i> date 24-Sep-2014

4.	Full Name	<b>Harukazu Miyamoto</b>
	Inventor's Signature	<i>Harukazu Miyamoto</i> date 25-Sep-2014

H20141113US1 H201411180US1

5.	Full Name	Kazuhito Miyata	
	Inventor's Signature	<i>Kazuhito Miyata</i>	date 24-SEP-2014
6.	Full Name	Kentaro Namikawa	
	Inventor's Signature	<i>Kentaro Namikawa</i>	date 24-SEP-2014
7.	Full Name	Atsuko Okawa	
	Inventor's Signature	<i>Atsuko Okawa</i>	date 1-OCT-2014
8.	Full Name		
	Inventor's Signature		date

TS  
H201411180001 H201411180001